

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Alfred Haeusler	11/30/2011
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13305536
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ATTORNEY DOCKET NUMBER:	TI-70431
NAME OF SUBMITTER:	Donna F. Williams
Total Attachments: 1 source=TI-70431_Assignment_signed#page1.tif	

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PATENT
REEL: 027356 FRAME: 0091

Application No. *13/305,536*

Attorney Docket No. TI-70431

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS DEUTSCHLAND GMBH, (hereinafter "TID"), a German company of Haggertystrasse 1, 85356 Freising, Germany, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s). _____, filed _____;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TID, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TID, as assignee of my entire right, title and interest.

I also hereby sell and assign to TID, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TID, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TID, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	FULLY EMBEDDED MICROMECHANICAL DEVICE, SYSTEM ON CHIP AND METHOD FOR MANUFACTURING THE SAME		
NONPROVISIONAL APPLICATION NO.	<i>13/305,536</i>	FILING DATE	<i>11/28/2011</i>

SIGNATURE OF INVENTOR	<i>Alfred Haeusler</i>
PRINTED NAME OF INVENTOR	Alfred HAEUSLER
DATE	<i>30. Nov 2011</i>
RESIDENCE (CITY AND STATE)	Freising, Germany

After recording, return Assignment to:

Donna Williams
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12500 TI Boulevard, M/S 3999
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